

# October UniFET<sup>™</sup>

# FDB38N30U N-Channel MOSFET, U-FRFET 300V, 38A, 0.12Ω

### Features

- $R_{DS(on)} = 0.103\Omega$  (Typ.) @  $V_{GS} = 10V$ ,  $I_D = 19A$
- Low gate charge ( Typ. 56nC )
- Low C<sub>rss</sub> ( Typ. 55pF )
- · Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS Compliant

## Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These device are well suited for high efficient switched mode power supplies and active power factor correction.





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol	Parameter			Ratings	Units
V <sub>DSS</sub>	Drain to Source Voltage			300	V
V <sub>GSS</sub>	Gate to Source Voltage			±30	V
I <sub>D</sub>	DrainCurrent	-Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		38	٨
		-Continuous ( $T_C = 100^{\circ}C$ )		22.8	Α
I <sub>DM</sub>	Drain Current	- Pulsed	- Pulsed (Note 1)		А
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	722	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	38	А
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	31.3	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20	V/ns
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)		313	W
		- Derate above 25°C		2.5	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

### **Thermal Characteristics**

Symbol	Parameter	Ratings	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case 0.4		
$R_{\theta CS}$	Thermal Resistance, Case to Sink	-	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	62.5	

		Device	Package	Reel Size	Таре	e Width		Quantity	V
		D2-PAK	330mm	24	4mm		800		
Electrica		<b>acteristics</b> T <sub>c</sub> = 25°C		·					
Symbol		Parameter	uniess otherw	Test Condition	s	Min.	Тур.	Max.	Unit
Off Charac	storistic			Test condition	3	WIIII.	тур.	Wax.	Unit
BV <sub>DSS</sub>	-	o Source Breakdown Voltage		$250 \mu \Lambda V_{\rm ext} = 0 V T_{\rm ext}$	- 25 <sup>0</sup> C	300	-	-	V
∆BV <sub>DSS</sub>		0		$I_D = 250 \mu A, V_{GS} = 0V, T_J = 25^{\circ}C$		300	-	-	
$\Delta T_J$	Breakdown Voltage Temperature Coefficient		_	$I_D = 250 \mu A$ , Referenced to $25^{\circ}C$		-	0.33	-	V/ºC
	Zero G	ate Voltage Drain Current		$V_{DS} = 300V, V_{GS} = 0V$		-	-	25	μA
I <sub>DSS</sub> Zero Gate Voltage Drain Curre		ale tonage Brain ouriont	-	= 240V, T <sub>C</sub> = 125 <sup>o</sup> C		-	-	250	μη
I <sub>GSS</sub>	Gate to Body Leakage Current		V <sub>GS</sub> :	$= \pm 30$ V, V <sub>DS</sub> $= 0$ V		-	-	±100	nA
On Charac	teristic	S							
V <sub>GS(th)</sub>	Gate T	hreshold Voltage	V <sub>GS</sub>	= V <sub>DS</sub> , I <sub>D</sub> = 250μA		3.0	-	5.0	V
R <sub>DS(on)</sub>	Static E	Drain to Source On Resistand	ce V <sub>GS</sub>	= 10V, I <sub>D</sub> = 19A		-	0.103	0.120	Ω
9 <sub>FS</sub>	Forward Transconductance		V <sub>DS</sub>	= 20V, I <sub>D</sub> = 19A	(Note 4)	-	30	-	S
Dynamic (	Charact	eristics							
C <sub>iss</sub>		apacitance				-	2510	3340	pF
C <sub>oss</sub>	Output	Capacitance		$V_{DS} = 25V, V_{GS} = 0V$ = 1MHz		-	470	625	pF
C <sub>rss</sub>	Revers	e Transfer Capacitance				-	55	85	pF
Q <sub>g(tot)</sub>	Total G	al Gate Charge at 10V				-	56	73	nC
Q <sub>gs</sub>	Gate to	Source Gate Charge		$V_{DS} = 240V, I_{D} = 38A$		-	14	-	nC
Q <sub>gd</sub>	Gate to	to Drain "Miller" Charge		V <sub>GS</sub> = 10V (Note 4, 5)		-	24	-	nC
Switching	Charac	teristics							
t <sub>d(on)</sub>	T	n Delay Time				-	33	76	ns
t <sub>r</sub>		Turn-On Rise Time Turn-Off Delay Time		$V_{DD} = 150V, I_D = 38A$ $R_G = 25\Omega$		-	80	170	ns
t <sub>d(off)</sub>						-	133	276	ns
•a(on) t <sub>f</sub>		ff Fall Time		(Note 4, 5)		-	62	134	ns
•					(				_
Jrain-Sou		de Characteristics	ce Diode Forw	ard Current		-		38	A
I <sub>SM</sub>	Maximum Pulsed Drain to Source Dide F					-	-	152	A
V <sub>SD</sub>	Drain to Source Diode Forward Voltage			$V_{GS} = 0V, I_{SD} = 38A$		-	-	1.4	V
t <sub>rr</sub>		e Recovery Time		$V_{GS} = 0V, I_{SD} = 38A$		-	60	-	ns
Q <sub>rr</sub>		e Recovery Charge		t = 100A/μs	(Note 4)	-	0.097	-	μΟ

3:  $I_{SD} \le 38A$ ,  $di/dt \le 200A/us$ ,  $V_{DD} \le BV_{DSS}$ . Starting  $T_J = 25^{\circ}C$ 4: Pulse Test: Pulse width  $\le 300\mu s$ , Duty Cycle  $\le 2\%$ 5: Essentially Independent of Operating Temperature Typical Characteristics















SEMICONDUCTOR

### TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

$2Cool^{TM}$ AccuPower <sup>TM</sup> AX-CAPT** BitSiC <sup>®</sup> Build it Now <sup>TM</sup> CorePLUS <sup>TM</sup> CorePOWER <sup>TM</sup> CorePOWER <sup>TM</sup> COSSVOLT <sup>TM</sup> CTL <sup>TM</sup> CUrrent Transfer Logic <sup>TM</sup> DEUXPECI Dual Cool <sup>TM</sup> EcoSPARK <sup>®</sup> EfficentMax <sup>TM</sup> ESBC <sup>TM</sup> ESBC <sup>TM</sup> ESBC <sup>TM</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild <sup>®</sup> Fairchild Semiconductor <sup>®</sup> FACT Quiet Series <sup>TM</sup> FACT <sup>®</sup> FastvCore <sup>TM</sup> FETBench <sup>TM</sup> FlashWriter <sup>®</sup> * FPS <sup>TM</sup>	F-PFS™ FRFET® Global Power Resource <sup>SM</sup> Green FPS™ Green FPS™ Green FPS™ GTO™ IntelliMAX™ ISOPLANAR™ Marking Small Speakers Sound I and Better™ MegaBuck™ MICROCOUPLER™ MicroPak™ MicroPak™ MicroPak™ MicroPak™ MillerDrive™ MotionMax™ MotionSPM™ mWSaver™ OptoHiT™ OPTOLOGIC® OPTOPLANAR®	PowerTrench <sup>®</sup> PowerXS <sup>™</sup> Programmable Active Droop <sup>™</sup> QFET <sup>®</sup> QS <sup>™</sup> Quiet Series <sup>™</sup> RapidConfigure <sup>™</sup> Outer Series <sup>™</sup> Saving our world, 1mW/W/kW at a time <sup>™</sup> Solutions for Your Success <sup>™</sup> SMART START <sup>™</sup> Solutions for Your Success <sup>™</sup> SPM <sup>®</sup> STEALTH <sup>™</sup> SuperSOT <sup>™</sup> -3 SuperSOT <sup>™</sup> -3 SuperSOT <sup>™</sup> -8 SuperSOT <sup>™</sup> -8 SuperS	The Power Franchise® The Power Franchise® Pranchise TinyBoost™ TinyCalc™ TinyCogic® TINYOPTOTM TinyOPWH™ TinyVWire™ TranSiC® TriFault Detect™ TRUECURRENT®* µSerDes™ UHC® UHC® UHC® UHC® UHC® UHTA FRFET™ VCXTM VisualMax™ VoltagePlus™ XSTM
---	--	---	--

\*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN. WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used here in:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### **PRODUCT STATUS DEFINITIONS** Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.